

March 2013

FDPF390N15A N-Channel PowerTrench[®] MOSFET 150 V, 15 A, 40 mΩ

Features

- $R_{DS(on)} = 31 \text{ m}\Omega \text{ (Typ.)} \otimes V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$
- Fast Switching Speed
- Low Gate Charge, Q_G = 14.3 nC(Typ.)
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

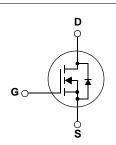
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor[®]'s advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Consumer Appliances
- LED TV
- Synchronous Rectification
- Uninterruptible Power Supply
- Motor Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol			FDPF390N15A	Unit		
V _{DSS}	Drain to Source Voltage		150	V		
V _{GSS}	Gate to Source Voltage			±20	V	
I _D	Drain Current	-Continuous (T _C = 25 ^o C,Silicon Limited)		15	^	
	Drain Current	-Continuous (T _C = 100°C,Silicon Limi	ted)	10	— A	
I _{DM}	Drain Current	- Pulsed (Note 1)		60	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			78	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		Note 3)	6.0	V/ns	
P _D	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		22	W	
	Power Dissipation	- Derate above 25°C		0.18	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

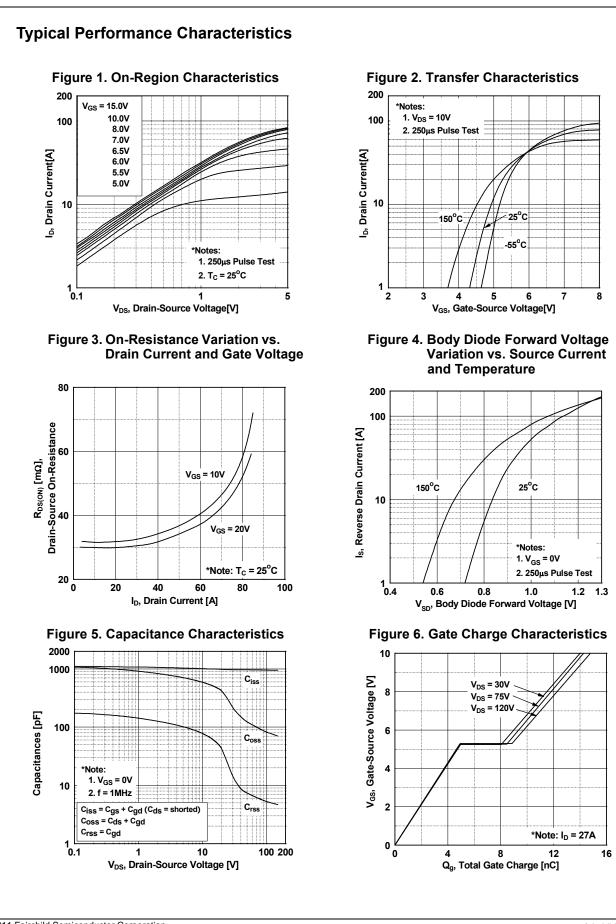
Symbol	Parameter	FDPF390N15A	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	5.7	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	0/11

Device Marking Device Pack		Packag	e	Reel Size	Таре	e Width		Quantity		
FDPF390	FDPF390N15A FDPF390N15A TO-22		TO-220	20F -			- 50			
Electrica	I Cha	racteristics $T_c =$	25ºC unless	otherwis	e noted					
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit
Off Charac	teristic	s								
BV _{DSS}	Drain t	o Source Breakdown V	oltage	I _D = 250μA, V _{GS} = 0V			150	-	-	V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient		ure	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$			-	0.1	-	V/ºC
I _{DSS}	Zero G	Zoro Gato Voltago Drain Current			120V, V _{GS} = 0V		-	-	1	μA
'DSS		Zero Gate Voltage Drain Current		$V_{DS} = 120V, T_{C} = 125^{\circ}C$			-	-	500	μι
I _{GSS}	Gate to	Body Leakage Curren	t	$V_{GS} =$	±20V, V _{DS} = 0V		-	-	±100	nA
On Charac	teristic	s								
V _{GS(th)}	Gate T	Gate Threshold Voltage			$V_{GS} = V_{DS}, I_{D} = 250 \mu A$			-	4.0	V
R _{DS(on)}	Static I	Drain to Source On Res	sistance	$V_{GS} = 10V, I_D = 15A$			-	31	40	mΩ
9 _{FS}	Forwa	Forward Transconductance			$V_{DS} = 10V, I_D = 15A$			32	-	S
Dynamic C	haract	eristics								
C _{iss}	Input C	apacitance		V _{DS} = 75V, V _{GS} = 0V f = 1MHz		-	965	1285	pF	
C _{oss}	Output	Capacitance				-	96	130	pF	
C _{rss}	Revers	e Transfer Capacitance	Э			-	5.8	-	pF	
C _{oss(er)}	Energy	nergy Related Output Capacitance		$V_{DS} = 75V, V_{GS} = 0V$				169	-	pF
Q _{g(tot)}	Total G	ate Charge at 10V		$V_{DS} = 75V, I_D = 27A$ $V_{GS} = 10V$		-	14.3	18.6	nC	
Q _{gs}		Source Gate Charge					5.0	-	nC	
Q _{gs2}		harge Threshold to Pla	Iteau			-	2.0	-	nC	
Q _{gd}		Drain "Miller" Charge		(Note 4)			-	3.5	-	nC
ESR	Equiva	lent Series Resistance	(G-S)	f = 1MHz			-	1.4	-	Ω
Switching	Charac	cteristics								
t _{d(on)}	Turn-O	n Delay Time		$V_{DD} = 75V, I_D = 27A$ $V_{GS} = 10V, R_{GEN} = 4.7\Omega$			-	14	38	ns
t _r	Turn-O	n Rise Time				-	10	30	ns	
t _{d(off)}	Turn-O	ff Delay Time				-	20	50	ns	
t _f	Turn-O	ff Fall Time		(Note 4)				5	20	ns
Drain-Sou	rce Dio	de Characteristic	S							
s	Maximu	um Continuous Drain to	Source Diode	e Forwa	rd Current		-	-	15	A
I _{SM}	Maximum Pulsed Drain to Source Diode F		Irce Diode For	Forward Current			-	-	64	Α
V _{SD}	Drain to	rain to Source Diode Forward Voltage		V _{GS} = 0V, I _{SD} = 15A			-	-	1.25	V
t _{rr}	Revers	e Recovery Time			0V, I _{SD} = 27A		-	63	-	ns
Q _{rr}	Revers	e Recovery Charge		dl _F /dt =	= 100A/µs	F	-	131	-	nC

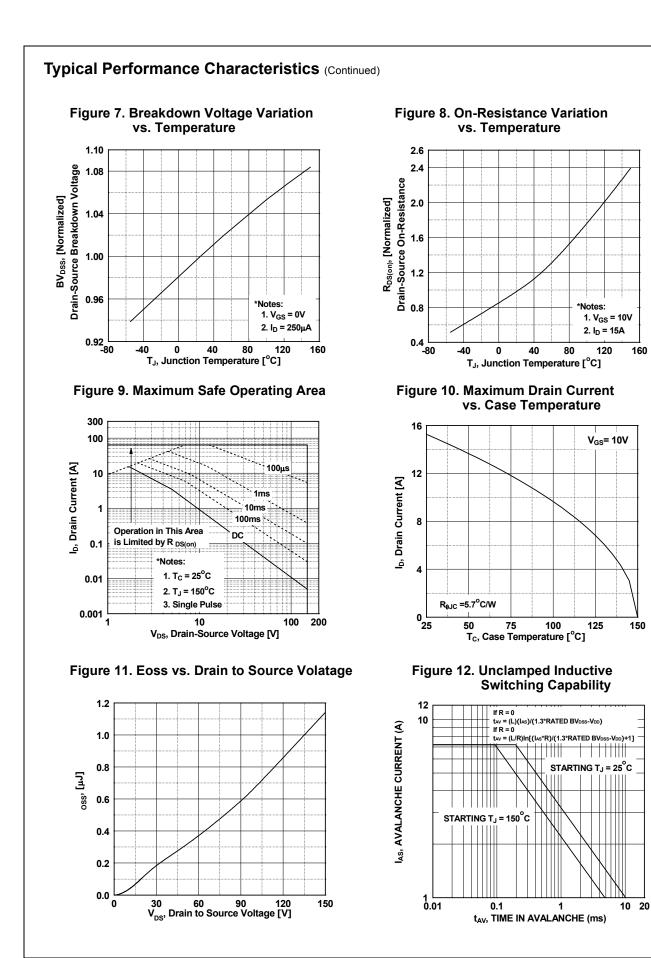
3. $I_{SD} \leq$ 15A, di/dt \leq 200A/µs, $V_{DD} \leq$ BV_{DSS}, Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics

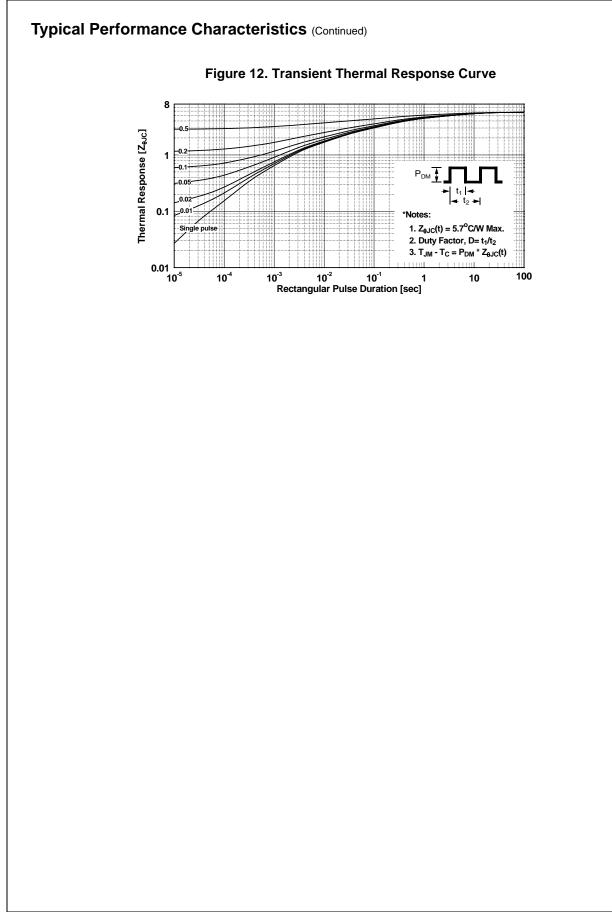
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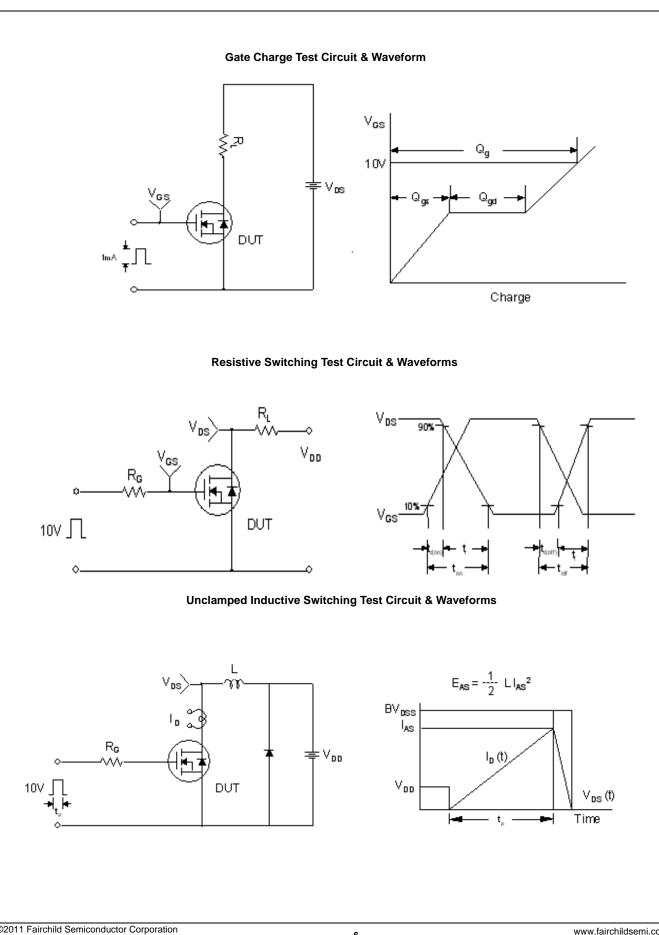


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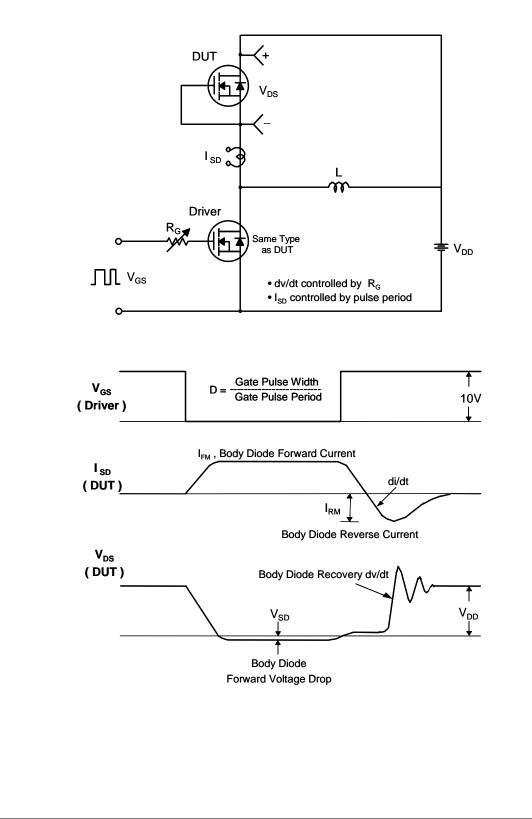


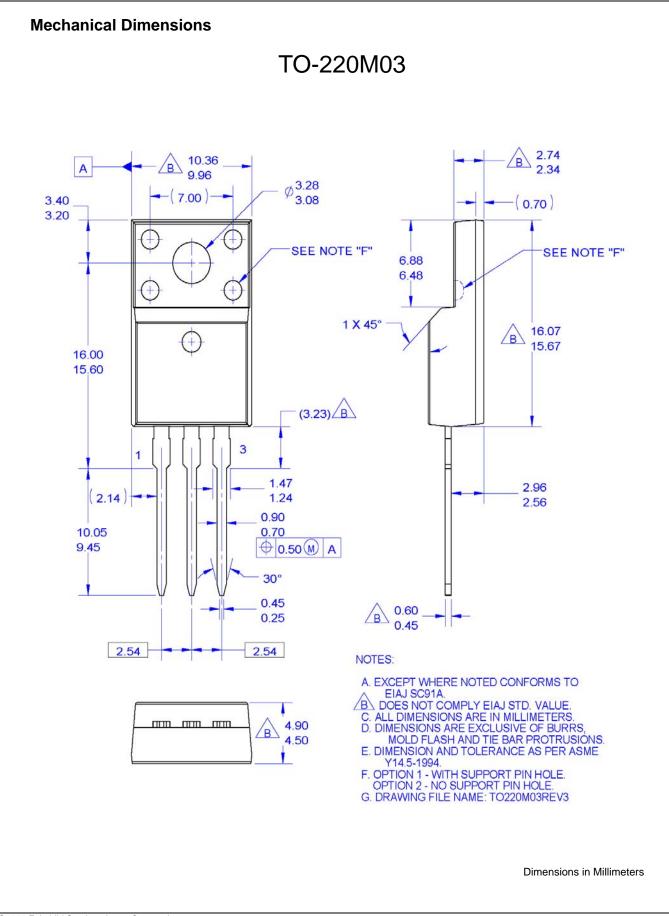
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